



FFA20U120DN

•	pose TO-3P ode power supply 1 2 3		
Power switc	hing circuits	1. Anode 2.Catho	ode 3. Anode
	FAST RECOVERY POWER RECTIFII Maximum Ratings (per diode) Tc=25°C unless other		
Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	1200	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	20	А
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	120	A
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C
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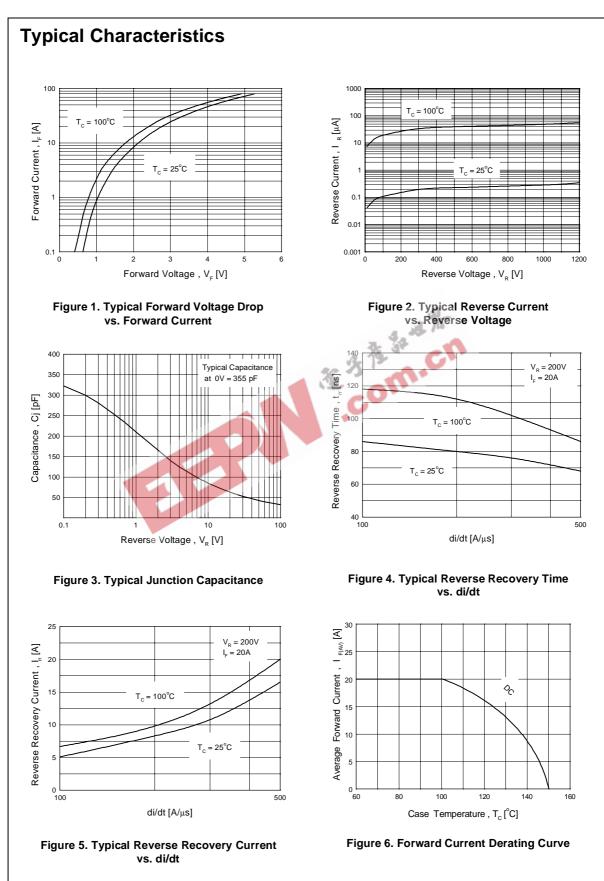
Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{ extsf{ heta}JC}$	Maximum Thermal Resistance, Junction to Case	0.84	°C/W

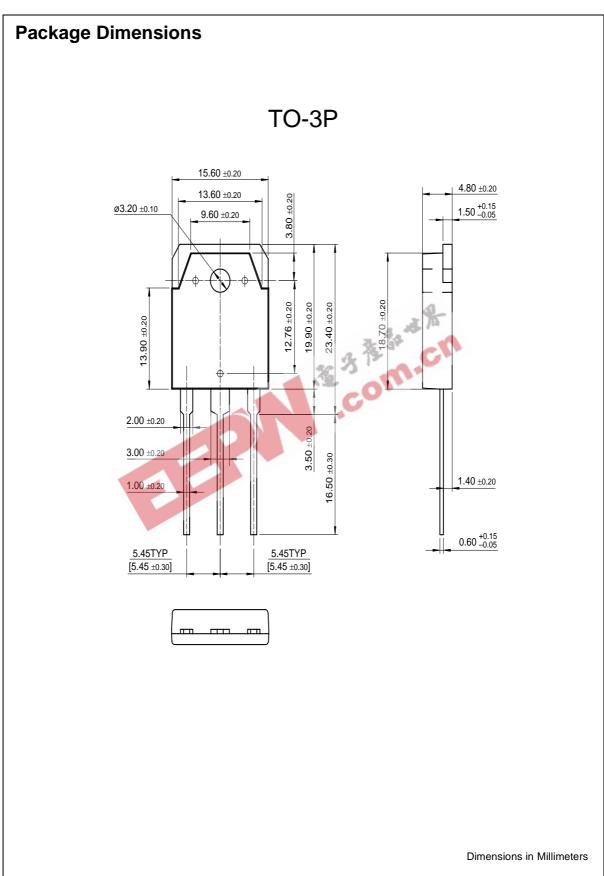
Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage	T 05.00			0.5	V
	I _F = 20A	$1_{\rm C} = 25 ^{\circ}{\rm C}$	-	-	3.5	
	I _F = 20A	T _C = 25 °C T _C = 100 °C	-	-	3.2	
RM *	Maximum Instantaneous Reverse Current					
	@ rated V _R	T _C = 25 °C	-	-	20	μA
		T _C = 25 °C T _C = 100 °C	-	-	1.2	mA
t _{rr}	Maximum Reverse Recovery Time		-	-	120	ns
rr	Maximum Reverse Recovery Current		-	-	10	А
Q _{rr}	Maximum Reverse Recovery Charge (I _F =20A, di/dt = 200A/μs)		-	-	500	nC
W _{AVL}	Avalanche Energy		1.0	-	-	mJ

t: Pulse Width=300µs, Duty Cycle=2%



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	•	Rev. F1